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PROCEEDINGS

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**Brian D. Corner
Masaaki Mochimaru
Robert Sitnik**
Editors

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Contents

vii Conference Committee

SESSION 1   **HARDWARE I**

- 6805 02   **Efficient acquisition and rendering of transparent and refractive objects using quotient image** [6805-01]
K. Ochiai, N. Tsumura, T. Nakaguchi, Chiba Univ. (Japan); K. Miyata, National Museum of Japanese History (Japan); Y. Miyake, Chiba Univ. (Japan)
- 6805 03   **Hybrid, contact, and no contact measurement system for industry** [6805-02]
R. Sitnik, Warsaw Univ. of Technology (Poland); J. Sładek, M. Kupiec, Cracow Univ. of Technology (Poland); P. Błaszczuk, W. Zatuski, Warsaw Univ. of Technology (Poland)
- 6805 04   **Inspection of microchip mounting tolerances by 3D vision** [6805-03]
S. Behler, M. von Arx, Oerlikon Assembly Equipment (Switzerland)

SESSION 2   **HARDWARE II**

- 6805 05   **A flexible 3D vision system based on structured light for in-line product inspection** [6805-04]
Ø. Skotheim, J. O. Nygaard, J. Thielemann, SINTEF ICT (Norway); T. Vollset, Tordivel AS (Norway)
- 6805 06   **Rapid 360 degree imaging and stitching of 3D objects using multiple precision 3D cameras** [6805-05]
T. Lu, JPL, CalTech (USA); S. Yin, The Pennsylvania State Univ. (USA); J. Zhang, Trellis Bioscience (USA); J. Li, F. Wu, Univ. of Northern California (USA)
- 6805 07   **Rangefinding system using hybrid pattern projections** [6805-06]
O. Kagiya, Y. Sato, H. Saito, Keio Univ. (Japan)
- 6805 08   **3D threat image projection** [6805-08]
Y. O. Yildiz, D. Q. Abraham, Analogic Corp. (USA); S. Agaian, Univ. of Texas at San Antonio (USA); K. Panetta, Tufts Univ. (USA)

SESSION 3   **3D DATA PROCESSING AND ALGORITHMS I**

- 6805 09   **Using hybrid approaches to solve the challenges of shape from shading** [6805-09]
R. Murphy, Z. J. Wood, California Polytechnic State Univ. (USA)
- 6805 0A   **An automatic alignment technique for multiple rangefinders** [6805-10]
K. Fujiwara, K. Yamauchi, Y. Sato, Keio Univ. (Japan)

- 6805 0B **Depth maps: faster, higher and stronger?** [6805-11]
I. A. Ideses, L. P. Yaroslavsky, B. Fishbain, Tel-Aviv Univ. (Israel)

SESSION 4 3D DATA PROCESSING AND ALGORITHMS II

- 6805 0D **Improved linearity using harmonic error rejection in a full-field range imaging system** [6805-13]
A. D. Payne, A. A. Dorrington, M. J. Cree, Univ. of Waikato (New Zealand); D. A. Carnegie, Victoria Univ. of Wellington (New Zealand)
- 6805 0E **Denoising techniques for raw 3D data of TOF cameras based on clustering and wavelets** [6805-14]
B. Moser, Software Competence Ctr. Hagenberg (Austria); F. Bauer, Univ. of Linz (Austria); P. Elbau, Johann Radon Institute for Computational and Applied Mathematics (Austria); B. Heise, Univ. of Linz (Austria); H. Schöner, Software Competence Ctr. Hagenberg (Austria)
- 6805 0F **Locating the source of topological error in reconstructed 3D models** [6805-15]
E. Firestone, C. Povey, Z. J. Wood, California Polytechnic State Univ. (USA)
- 6805 0G **Using quality metrics with laser range scanners** [6805-16]
D. MacKinnon, Carleton Univ. (Canada) and National Research Council Canada (Canada); V. Aitken, Carleton Univ. (Canada); F. Blais, National Research Council Canada (Canada)

SESSION 5 ENVIRONMENT SCANNING

- 6805 0H **Estimating building floor plans from exterior using laser scanners** [6805-17]
M. Johnston, A. Zakhor, Signetron, Inc. (USA)
- 6805 0I **Reconstruction of 3D indoor model by scalable sensing using mobile robot** [6805-18]
K. Fujimoto, The Univ. of Electro-Communications (Japan); F. Beniyama, T. Moriya, Hitachi, Ltd. (Japan); Y. Nakayama, The Univ. of Electro-Communications (Japan)

SESSION 6 3D PRINTING AND DISPLAY

- 6805 0J **Optical implementation of improved resolution with intermediate-view reconstruction technique based on integral imaging** [6805-19]
K.-J. Lee, Kwangwoon Univ. (South Korea); S.-T. Lee, Presidential Security Service (South Korea); Y.-S. Oh, S.-P. Hong, C.-K. Kim, E.-S. Kim, Kwangwoon Univ. (South Korea)
- 6805 0L **Specifying colour and maintaining colour accuracy for 3D printing** [6805-21]
C. Parraman, P. Walters, B. Reid, D. Huson, Univ. of the West of England (United Kingdom)

SESSION 7 HUMAN SCANNING I

- 6805 0M **A novel sensor system for 3D face scanning based on infrared coded light** [6805-22]
D. Modrow, C. Laloni, G. Doemens, Siemens AG (Germany); G. Rigoll, Technische Univ. München (Germany)

- 6805 ON **Comparison of Cyberware PX and PS 3D human head scanners** [6805-23]
J. Carson, B. D. Corner, U.S. Army Natick Soldier RDEC (USA); E. Crockett, Univ. Massachusetts, Dartmouth (USA); P. Li, SAIC (USA); S. Paquette, U.S. Army Natick Soldier RDEC (USA)
- 6805 OP **A calibration method of multiple rangefinders system** [6805-25]
H. Kameshima, Y. Sato, H. Saito, Keio Univ. (Japan)
- 6805 OQ **3D monitoring of the intraoperative brainshift by means of photogrammetry** [6805-26]
N. D'Apuzzo, Hometrica Consulting (Switzerland); M. Verius, Univ. Klinik f. Radiodiagnostik II, Univ. Innsbruck (Austria)

SESSION 8 HUMAN SCANNING II

- 6805 OR **An efficient stochastic framework for 3D human motion tracking** [6805-27]
B. Ni, S. Winkler, A. A. Kassim, National Univ. of Singapore (Singapore)
- 6805 OS **FaceTOON: a unified platform for feature-based cartoon expression generation** [6805-28]
T. Zaharia, Institut TELECOM (France); O. Marre, QuadraX Co. (France); F. Prêteux, P. Monjaux, Institut TELECOM (France)
- 6805 OT **Person and gesture tracking with smart stereo cameras** [6805-29]
G. Gordon, X. Chen, R. Buck, TYZX, Inc. (USA)
- 6805 OU **Intelligent noncontact surgeon-computer interface using hand gesture recognition** [6805-30]
M. Zhao, Etonnet, Inc. (USA); A. G. Nowatzky, Cedars-Sinai Medical Ctr. (USA); T. Lu, Etonnet, Inc. (USA); D. L. Farkas, Cedars-Sinai Medical Ctr. (USA)

INTERACTIVE PAPER SESSION

- 6805 OW **Distributed RANSAC for 3D reconstruction** [6805-32]
M. Xu, M. Petrou, Imperial College London (United Kingdom)
- 6805 OX **Analyzing the influence of camera temperature on the image acquisition process** [6805-33]
H. Handel, Univ. of Mannheim (Germany)
- 6805 OY **3D reconstruction and spatial auralization of the Painted Dolmen of Antelas** [6805-34]
P. Dias, G. Campos, Univ. of Aveiro (Portugal) and Instituto de Engenharia Electrónica e Telemática de Aveiro (Portugal); V. Santos, R. Casaleiro, R. Seco, Univ. of Aveiro (Portugal); B. Sousa Santos, Univ. of Aveiro (Portugal) and Instituto de Engenharia Electrónica e Telemática de Aveiro (Portugal)
- 6805 OZ **A method for converting three-dimensional models into auto-stereoscopic images based on integral photography** [6805-35]
M. Katayama, Y. Iwadata, NHK Science & Technical Research Labs. (Japan)

- 6805 10   **Synthesis of arbitrary viewpoint image from images of multiple weakly calibrated camera images using all in-focus rendering method** [6805-36]
Y. Matsumura, Y. Sakamoto, Hokkaido Univ. (Japan)
- 6805 11   **High-speed depth-mapping axi-vision camera with compact optical system** [6805-37]
T. Aida, T. Uragaki, Osaka City Univ. (Japan); M. Kawakita, NHK Science & Technical Research Labs. (Japan); Y. Tomita, R. Tsunoi, NHK Engineering Service Inc. (Japan); S. Yahagi, M. Tanaka, Fujinon Corp. (Japan); H. Mitake, Shinko Electric Co., Ltd. (Japan); M. Tawara, Visual Design Co., Ltd. (Japan)
- 6805 12   **Small 3D image capturing system by TOMBO** [6805-38]
K. Yamada, Hiroshima Institute of Technology (Japan); H. Takahashi, Osaka City Univ. (Japan)
- 6805 13   **Priority depth fusion for the 2D to 3D conversion system** [6805-39]
Y.-L. Chang, W.-Y. Chen, J.-Y. Chang, Y.-M. Tsai, C.-L. Lee, L.-G. Chen, National Taiwan Univ. (Taiwan)

Author Index

Conference Committee

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Session Chairs

- 1 Hardware I
Brian D. Corner, U.S. Army Soldier Systems Center (USA)
- 2 Hardware II
Robert Sitnik, Politechnika Warszawska (Poland)
- 3 3D Data Processing and Algorithms I
Masaaki Mochimaru, National Institute of Advanced Industrial Science and Technology (Japan)
- 4 3D Data Processing and Algorithms II
Brian D. Corner, U.S. Army Soldier Systems Center (USA)
- 5 Environment Scanning
Brian D. Corner, U.S. Army Soldier Systems Center (USA)
- 6 3D Printing and Display
Robert Sitnik, Politechnika Warszawska (Poland)
- 7 Human Scanning I
Masaaki Mochimaru, National Institute of Advanced Industrial Science and Technology (Japan)
- 8 Human Scanning II
Brian D. Corner, U.S. Army Soldier Systems Center (USA)